

## EELE 461/561 – Digital System Design

### Module #5 – Crosstalk

- **Topics**
  1. Near-End and Far-End Crosstalk
  2. Simultaneous Switching Noise
- **Textbook Reading Assignments**
  1. 10.1-10.12, 10.18
- **What you should be able to do after this module**
  1. Calculate NEXT & FEXT
  2. Calculate ground bounce
  3. Use a modern CAD tool to extract crosstalk parameters for an interconnect structure



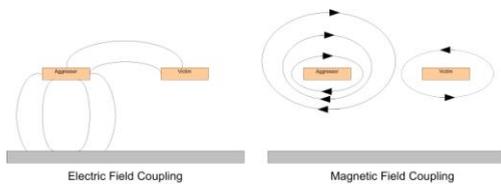
## Crosstalk

- **Crosstalk**
  - Crosstalk (or X-talk) is when the switching on one signal causes noise on an adjacent line.
  - The Crosstalk can be due to Electric or Magnetic Field lines interacting with a neighboring line.
  - The term Crosstalk comes from the early analog phone lines where you could actually hear voices from neighboring lines due to EM coupling.
  - Cross talk is due to the capacitance and inductance between conductors, which we call:
    - "Mutual Capacitance" ( $C_M$ )
    - "Mutual Inductance" ( $L_M$ )
- **Superposition**
  - Crosstalk is based on the principle of Superposition where:
    - 1) Multiple signals can exist on the same line without interacting or effecting each other.
    - 2) An arbitrary signal can be coupled onto a line independent of what may already exist on that line.



## Crosstalk

- **Crosstalk Terminology**
  - We call the switching signal the "Aggressor"
  - We call the line receiving the noise the "Victim"



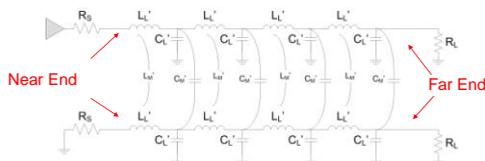
## Crosstalk

- **Crosstalk Classes**
  - There are two main classes of X-talk:
    - 1) Signal X-talk
      - When  $C_M$  and  $L_M$  produce X-talk noise on the same order of magnitude
      - When the signal path is the reason for the X-talk
      - This is what we see on PCB's and on-chip traces
    - 2) Switching Noise
      - When the return path is highly inductive and the inductive noise dominates
      - When the inductance in the return path is the reason for the X-talk
      - This is what we see on packages and in connectors
      - This is also called:
        - "Ground Bounce / Power Supply Droop"
        - "Simultaneous Switching Noise (SSN)"
        - "Simultaneous Switching Output (SSO) Noise"



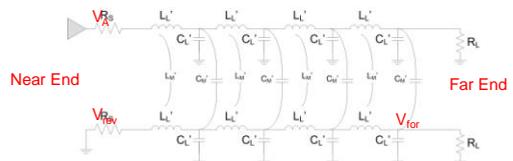
## Crosstalk

- **Crosstalk Location**
  - There are two locations where we observe and define X-talk
    - Near End - the location closest to the driving source resistor
    - Far End - the location closest to the receiving termination resistor



## Crosstalk

- **Crosstalk Definitions**
  - We define parameters for X-talk based on a double terminated system.
    - NEXT - Near End Crosstalk Coefficient ( $V_{ne}/V_s$ )
    - FEXT - Far End Crosstalk Coefficient ( $V_{fe}/V_s$ )



## Crosstalk

### SPICE Matrixes

- There can be multiple signal lines in a system
- To keep track of their LC values, we use a matrix
- Each signal is given an index, where ground is "0"
- We define  $C_{11}$  as the self capacitance of signal 1 (and also for C22, C33, etc...)
- We define  $C_{12}$  as the mutual capacitance between signals 1 and 2 (and also for C13, C23, etc...)
- In this system,  $C_{12}$  and  $C_{21}$  are equal
- We then put all the values in a Matrix for easy record keeping
- We do the same for the Inductances



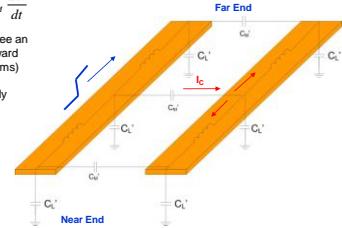
## Crosstalk

### Capacitive Crosstalk

- As the Aggressor Edge propagates down the line, it will inject current into the Victim line through the Mutual Capacitance following:

$$I_c = C_M \frac{dV}{dt}$$

- As the current is injected, it will see an equal impedance in both the forward and reverse directions (i.e., 50ohms)
- As a result, the current will equally split and half will travel forward and half will travel backwards



## Crosstalk

### Capacitive Crosstalk

- The total amount of current injected at any given time is related to the spatial extent of the risetime
- This can be described using the per unit length value for Mutual Capacitance ( $C_M$ )

$$C_M = C_M' \cdot \Delta x$$

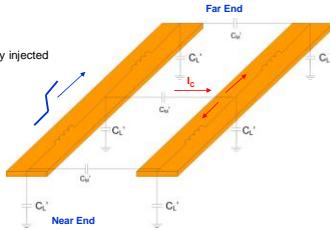
$$C_M = C_M' \cdot (vel \cdot t_{rise})$$

- The total amount of instantaneously injected current is then described by:

$$I_c = C_M \frac{dV}{dt}$$

$$I_c = C_M' \cdot (vel \cdot t_{rise}) \cdot \left(\frac{V}{t_{rise}}\right)$$

$$I_c = C_M' \cdot vel \cdot V$$



## Crosstalk

### Capacitive Crosstalk (Near End)

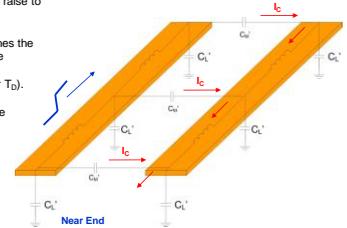
- Half of the current injected into the victim as the incidence voltage step travels down the aggressor travels back to the Near End.

- At any given time, only a fixed amount of current will be observed at the Near End

- This means the Near End voltage will raise to a fixed value and remain there.

- At the point the aggressor edge reaches the end of the line ( $T_D$ ), the injected noise on the victim still needs to travel back to the Near-End (taking another  $T_D$ ).

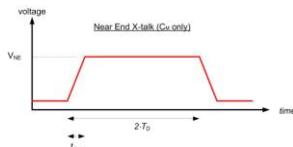
- This means the fixed noise level at the Near End will remain for  $2 \cdot T_D$



## Crosstalk

### Capacitive Crosstalk (Near End)

- This gives a voltage profile at the near-end as follows:



- The maximum amount of current injected is reduced by a factor of 1/2 to account for the injected energy splitting in both the forward & reverse directions.

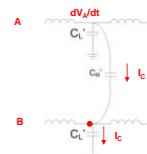
- This current is further reduced by an additional factor of 1/2 to account for the energy being spread out over  $2 \cdot T_D$

$$I_c = \left(\frac{1}{2}\right) \cdot \left(\frac{1}{2}\right) \cdot C_M' \cdot vel \cdot V = \left(\frac{1}{4}\right) \cdot C_M' \cdot vel \cdot V$$

## Crosstalk

### Capacitive Crosstalk (Near End)

- We can convert this into a ratio of Voltages by looking at KCL at an arbitrary point of injection.

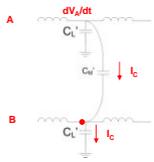


- a  $dV/dt$  occurs on the aggressor node which is seen across the  $C_M$  of the aggressor and  $C_M$  of the victim.

(NOTE: we assume that the victim line is at 0volts for our derivation)

### Crosstalk

- Capacitive Crosstalk (Near End)**
  - this change in voltage causes a current to flow through  $C_M$  given by:
 
$$I_{C_M} = C_M \cdot \frac{dV}{dt} = C_M \cdot \frac{(0.8) \cdot V_A}{t_{rise}}$$
  - when this current reaches the victim line and evaluate KCL, it instantaneously sees opens in the directions of the Inductors due to their high impedances at AC. As a result 100% of the current flows into  $C_L$  of the victim.
 
$$I_{C_M} = I_{C_L}$$
  - This current in  $C_L$  then creates a  $dV/dt$  given by:
 
$$I_{C_L} = C_L \cdot \frac{dV}{dt} = C_L \cdot \frac{(0.8) \cdot V_B}{t_{rise}}$$



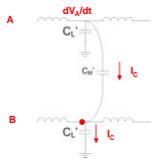
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### Crosstalk

- Capacitive Crosstalk (Near End)**
  - we can now relate the magnitude of the voltage observed on the aggressor ( $V_A$ ) to the voltage on the aggressor ( $V_B$ )
 
$$I_{C_M} = I_{C_L}$$

$$C_M \cdot \frac{(0.8) \cdot V_A}{t_{rise}} = C_L \cdot \frac{(0.8) \cdot V_B}{t_{rise}}$$

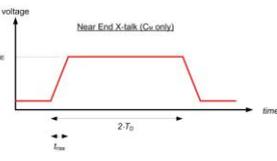
$$\frac{V_B}{V_A} = \frac{C_M}{C_L}$$
  - this is the total voltage created at the injection point prior to the inductors beginning to conduct and allowing the current to flow in both the forward and reverse directions.



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### Crosstalk

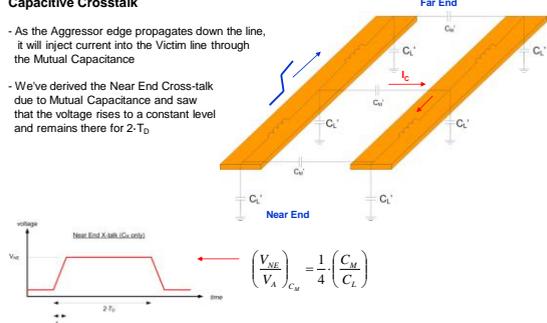
- Capacitive Crosstalk (Near End)**
  - we now apply our 1/4 factor to come up with our final expression for the magnitude of the capacitively coupled voltage observed at the Near-End
 
$$\left( \frac{V_{NE}}{V_A} \right)_{C_M} = \frac{1}{4} \left( \frac{C_M}{C_L} \right)$$



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### Crosstalk

- Capacitive Crosstalk**
  - As the Aggressor edge propagates down the line, it will inject current into the Victim line through the Mutual Capacitance
  - We've derived the Near End Cross-talk due to Mutual Capacitance and saw that the voltage rises to a constant level and remains there for  $2 \cdot T_D$



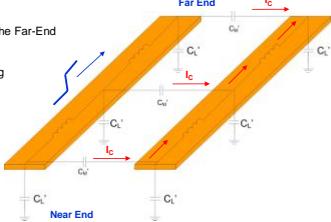
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### Crosstalk

- Capacitive Crosstalk (Far End)**
  - Now we look at the Noise observed at the Far-End of the Victim line.
  - This noise is due to the forward traveling current that is injected through  $C_M$ .
 
$$I_C = C_M \cdot \frac{dV}{dt}$$

$$I_C = C_M \cdot (vel \cdot t_{rise}) \cdot \left( \frac{V}{t_{rise}} \right)$$

$$I_C = C_M \cdot vel \cdot V$$
  - 1/2 of this current travels forward toward the Far-End.
  - The current noise is not seen until the Aggressor incident wave reaches the Far-End

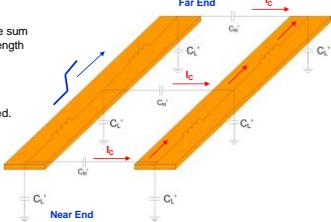


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### Crosstalk

- Capacitive Crosstalk (Far End)**
  - The net voltage at the far end will be the sum of all of the injected current along the length of the coupled line.
  - The TOTAL amount of current that is injected through  $C_M$  is proportional to the total length that the lines are coupled.
 
$$I_{C_M} = C_M \cdot \frac{dV}{dt}$$

$$I_{C_M} = C_M \cdot (length) \cdot \left( \frac{0.8 \cdot V_A}{t_{rise}} \right)$$



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### Crosstalk

- Capacitive Crosstalk (Far End)**
  - All of the current that is injected into the victim line will add together and be injected into the last  $C_L$  segment of the Victim at the Far-End
  - The current in the last segment is described as:

$$I_{C_v} = C_L \cdot \Delta x \cdot \frac{dV}{dt}$$

$$I_{C_v} = C_L \cdot (vel \cdot t_{rise}) \cdot \frac{(0.8) \cdot V_B}{t_{rise}}$$

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### Crosstalk

- Capacitive Crosstalk (Far End)**
  - We can now relate the total current injected along the line to the voltage induced at the Far-End using:

$$I_{C_v} = I_{C_L}$$

$$C_M \cdot (length) \cdot \left( \frac{0.8 \cdot V_A}{t_{rise}} \right) = C_L \cdot (vel \cdot t_{rise}) \cdot \frac{(0.8) \cdot V_B}{t_{rise}}$$

$$\left( \frac{V_B}{V_A} \right)_{FE} = \left( \frac{length}{vel \cdot t_{rise}} \right) \left( \frac{C_M}{C_L} \right)$$

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### Crosstalk

- Capacitive Crosstalk (Far End)**
  - We now apply our factor of 1/2 to account for the forward and reverse traveling current and we get:

$$\left( \frac{V_{FE}}{V_A} \right)_{C_v} = \frac{1}{2} \left( \frac{length}{vel \cdot t_{rise}} \right) \left( \frac{C_M}{C_L} \right)$$

NOTE: The magnitude of FE X-talk can get very large because it is proportional to coupled length and inversely proportional to  $t_{rise}$

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### Crosstalk

- Inductive Crosstalk**
  - Magnetic Fields exist as the current travels down the Aggressor line.
  - These B-field lines induce B-field lines around the Victim line, which in turn creates current.
  - The direction of the B-field lines in the Aggressor follow the Right-Hand-Rule.
  - The direction of the B-field lines in the Victim are opposite of the Aggressor.

Magnetic Field Coupling

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### Crosstalk

- Inductive Crosstalk**
  - The B-Field lines induced on the Victim create a current that flows in the opposite direction of the Aggressor current.

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### Crosstalk

- Inductive Crosstalk**
  - The direction of the induced current creates a Negative Voltage at the Far-End and a Positive Voltage at the Near-End as it flows through the termination impedances.

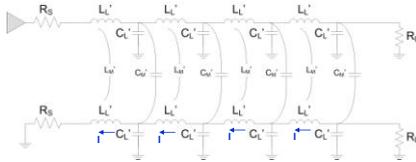
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## Crosstalk

### Inductive Crosstalk (Near End)

- Just as in Near-End Capacitive X-talk, the currents that are induced by the inductive coupling will travel back to the Source (or Near End) over a time span of  $2 \cdot T_D$



## Crosstalk

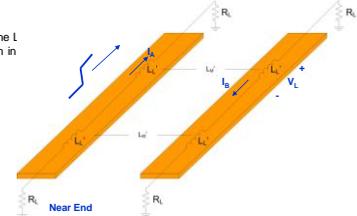
### Inductive Crosstalk (Near End)

- The current that flows through the self inductance of the Aggressor line causes a voltage on the Victim line as follows:

$$V_M = L_M \cdot \frac{dI_A}{dt}$$

- This voltage appears across the L inductance of the Victim which in causes a current to flow:

$$V_L = L_L \cdot \frac{dI_B}{dt}$$



## Crosstalk

### Inductive Crosstalk (Near End)

- Since the coupled voltage ( $V_M$ ) is the same as the Victim line voltage ( $V_L$ ) which creates the current, we can relate the currents of the Aggressor and Victim.

$$V_M = V_L$$

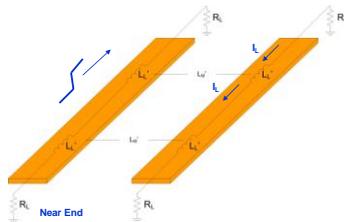
$$L_M \cdot \frac{dI_A}{dt} = L_L \cdot \frac{dI_B}{dt}$$

$$L_M \cdot \frac{I_A}{t_{rise}} = L_L \cdot \frac{I_B}{t_{rise}}$$

- This can be converted to voltage by multiplying the current by the impedance (which is the same in both lines):

$$L_M \cdot \frac{I_A \cdot Z}{t_{rise}} = L_L \cdot \frac{I_B \cdot Z}{t_{rise}}$$

$$L_M \cdot \frac{V_A}{t_{rise}} = L_L \cdot \frac{V_B}{t_{rise}}$$



## Crosstalk

### Inductive Crosstalk (Near End)

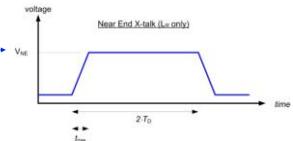
- Now we have a relationship between the Aggressor and Near-End Victim Voltages:

$$L_M \cdot \frac{V_A}{t_{rise}} = L_L \cdot \frac{V_B}{t_{rise}}$$

$$\frac{L_M}{L_L} = \frac{V_B}{V_A}$$

- We now apply a factor of 1/2 for the forward/reverse traveling current and 1/2 to account for the energy being split over  $2 \cdot T_D$

$$\left( \frac{V_{NE}}{V_A} \right)_{L_M} = \frac{1}{4} \cdot \left( \frac{L_M}{L_L} \right)$$

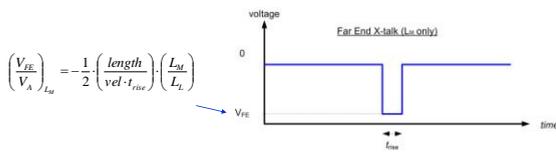


## Crosstalk

### Inductive Crosstalk (Far End)

- The exact derivation is applied to the Far-End inductive X-talk to derive the maximum amount of noise due to Inductive coupling.

- The only difference is that the magnitude of the Far-End noise is **NEGATIVE**.



$$\left( \frac{V_{FE}}{V_A} \right)_{L_M} = -\frac{1}{2} \cdot \left( \frac{\text{length}}{\text{vel} \cdot t_{rise}} \right) \cdot \left( \frac{L_M}{L_L} \right)$$



## Crosstalk

### NEXT

- We can combine all of the coupling at the Near-End to come up with the

**Near End Crosstalk Coefficient (NEXT)**

$$NEXT = \left( \frac{V_{NE}}{V_A} \right)_{L_M} = \frac{1}{4} \cdot \left( \frac{C_M + L_M}{C_L + L_L} \right) = k_n$$

- We define  $k_n$  as the **Backward Coefficient** which is only in terms of intrinsic values.



## Crosstalk

- FEXT**

- We can combine all of the coupling at the Far-End to come up with the

**Far End Crosstalk Coefficient (FEXT)**

$$FEXT = \left( \frac{V_{FE}}{V_A} \right) = \frac{1}{2} \cdot \left( \frac{\text{length}}{\text{vel} \cdot t_{rise}} \right) \cdot \left( \frac{C_M - L_M}{C_L - L_L} \right)$$

- We define  $k_f$  as the **Forward Coefficient** which is only in terms of intrinsic values.

$$k_f = \frac{1}{2 \cdot \text{vel}} \cdot \left( \frac{C_M - L_M}{C_L - L_L} \right)$$

where,

$$FEXT = \left( \frac{\text{length}}{\text{vel} \cdot t_{rise}} \right) \cdot k_f$$



## Crosstalk

- Total X-talk**

- If we look at NEXT, we see that:

$$NEXT = \left( \frac{V_{NE}}{V_A} \right) = \frac{1}{4} \cdot \left( \frac{C_M + L_M}{C_L - L_L} \right) = k_b$$

- 1) Near End X-talk doesn't depend on risetime
- 2) Near End X-talk is always positive (for a rising edge on the Aggressor)

- If we look at FEXT, we see that:

$$FEXT = \left( \frac{V_{FE}}{V_A} \right) = \frac{1}{2} \cdot \left( \frac{\text{length}}{\text{vel} \cdot t_{rise}} \right) \cdot \left( \frac{C_M - L_M}{C_L - L_L} \right)$$

- 1) Far End X-talk depends on coupled length and  $t_{rise}$
- 2) FE X-talk can actually **cancel** if the ratios of Capacitance and Inductance are equal

- NOTE: this cancellation occurs if all of the field lines are contained within a homogeneous dielectric.



## Crosstalk

- Scaling Near-End X-talk**

- If the coupled length of the T-line is shorter than the risetime, the peak value of NEXT will not reach its maximum value.

- We scale the maximum value that it will reach using:

$$NE_{scaling} = \frac{\text{Length of Coupled Region}}{\text{Length of Risetime}}$$

- Risetime is converted to **Length** using:

$$\text{length}_{rise} = \text{vel} \cdot t_{rise}$$



## Crosstalk

- Switching Noise**

- We've covered the 1st class of X-talk (Signal X-talk)

- Now we turn to the 2nd class of Crosstalk:

2) Switching Noise

- When the return path is highly inductive and the inductive noise dominates
- When the inductance in the return path is the reason for the X-talk
- This is what we see on packages and in connectors
- This is also called:

"Ground Bounce / Power Supply Droop"

or

"Simultaneous Switching Noise (SSN)"

or

"Simultaneous Switching Output (SSO) Noise"



## Crosstalk

- Switching Noise**

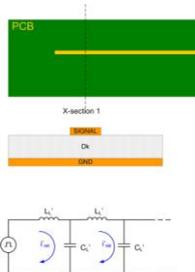
- When we derived the LC model of a transmission line, we assumed that the ground (or return path) was a perfect conductor.

- That allowed us to model the ground with a simple wire.

- This is reasonable in a transmission line when the ground conductor is much larger than the signal conductor.

Ex) PCB trace:

- the signal sees an *infinite* ground plane beneath it.

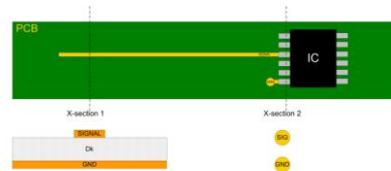


## Crosstalk

- Switching Noise**

- When the signal travels through connectors or packages, the shape of the return path changes.

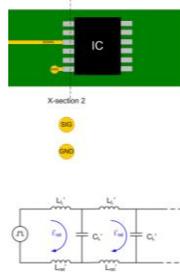
- This typically results in a return path with the same geometry as the signal.



## Crosstalk

### Switching Noise

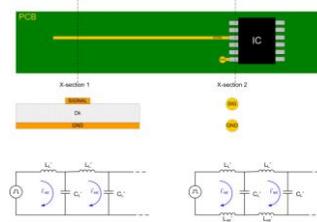
- This means we need to model the return path's electrical properties.
- The capacitance between the signal and ground is already present in our LC model.
- However, we need to add an inductive component into the return path for an accurate model



## Crosstalk

### Switching Noise

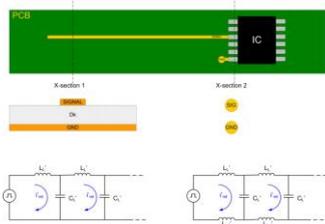
- This geometry change in the conductors results in a highly inductive path that the current needs to flow through.
- In addition, the capacitance typically is reduced due to the surface area of the connector/package being less than in the trace section of the link.



## Crosstalk

### Switching Noise

- This inductive interconnect is the source of *Switching Noise*

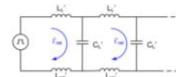


## Crosstalk

### Switching Noise (Ground Bounce)

- The return current that passes through the inductive interconnect causes a voltage to form following:

$$V_N = L_{ret} \cdot \frac{dI}{dt}$$



- This voltage changes the ground potential of the integrated circuit relative to the ground of the system which gives the name *Ground Bounce*



## Crosstalk

### Switching Noise (Ground Bounce)

- This becomes a more critical problem when signals in packages and connectors share a common return pin.
- It is cost effective to reduce the pin count of packages/connectors by sharing ground pins.
- However, the Ground Bounce now becomes proportional to the # of signal lines using that return pin.

$$V_N = \left( L_{ret} \cdot \frac{dI}{dt} \right) \cdot (\# \text{ of signals})$$

- This can be related to voltage by using  $V=IZ$

$$V_N = \left( L_{ret} \cdot \frac{0.8 \cdot V_A}{t_{rise} \cdot Z_0} \right) \cdot (\# \text{ of signals})$$



## Crosstalk

### Switching Noise (Ground Bounce)

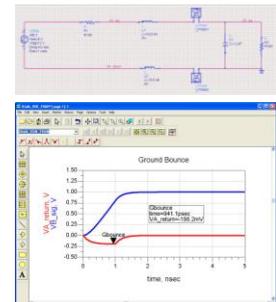
- ex)  $L_{ret} = 10nH$   
 $t_{rise} = 800ps$   
 $Z_0 = 50\Omega$

$$V_{G\text{bounce}} = \left( L_{ret} \cdot \frac{0.8 \cdot V_A}{t_{rise} \cdot Z_0} \right) \cdot (\# \text{ of signals})$$

$$V_{G\text{bounce}} = \left( 10n \cdot \frac{0.8 \cdot 1}{800p \cdot 50} \right) \cdot (1)$$

$$V_{G\text{bounce}} = -0.2v$$

- a positive  $dv/dt$  causes current to flow back to the source. The inductor acts as a passive element in this case so the voltage induced causes the source ground to become negative.



## Crosstalk

### Switching Noise (Mutual Inductance)

- there is also mutual inductance that couples between the signal inductance and the return path inductance.
- in this case, the inductor acts as a voltage source in the return path, which creates a voltage in the opposite polarity as the noise caused by the return current.
- this actually has the result of *decreasing* the total inductive ground bounce noise and can be a good thing.
- however, this is a secondary effect compared to the noise generated when multiple signals share a common return path.



## Crosstalk

### Switching Noise (Mutual Inductance)

- ex)  $L_{sig} = 10nH$   
 $L_{ret} = 2.5nH$   
 $t_{rise} = 800ps$   
 $Z_0 = 50\Omega$

$$V_{NM} = \left( L_M \cdot \frac{0.8 \cdot V_s}{t_{rise} \cdot Z_0} \right)$$

$$V_{NM} = \left( 2.5n \cdot \frac{0.8 \cdot 1}{800p \cdot 50} \right)$$

$$V_{NM} = +0.05v$$

- Mutual inductive coupling causes the return inductor to act as a voltage source so the resultant voltage is opposite in polarity to the return noise. The total voltage in this case is:  $-0.2 + 0.05 = -0.15v$

